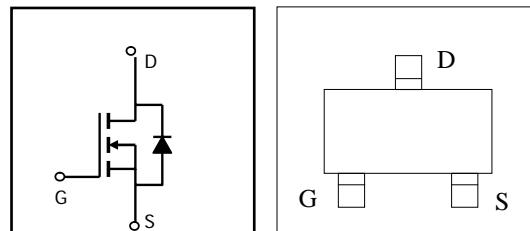
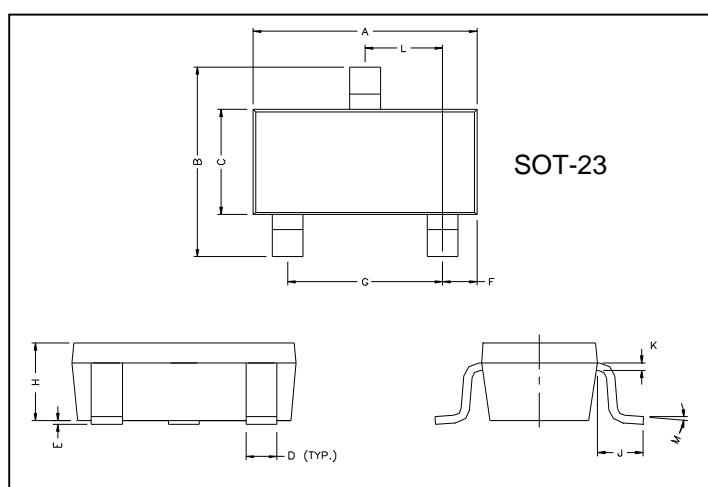


## 30V N-Channel Enhancement Mode MOSFET

**VDS= 30V****RDS(ON), Vgs@10V, Ids@5.8A < 30mΩ****RDS(ON), Vgs@4.5V, Ids@5.0A < 33mΩ****RDS(ON), Vgs@2.5V, Ids@4.0A < 52mΩ****Features**

Advanced trench process technology

High Density Cell Design For Ultra Low On-Resistance



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.80	3.00	G	1.80	2.00
B	2.30	2.50	H	0.90	1.1
C	1.20	1.40	K	0.10	0.20
D	0.30	0.50	J	0.35	0.70
E	0	0.10	L	0.92	0.98
F	0.45	0.55	M	0°	10°

## Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted)

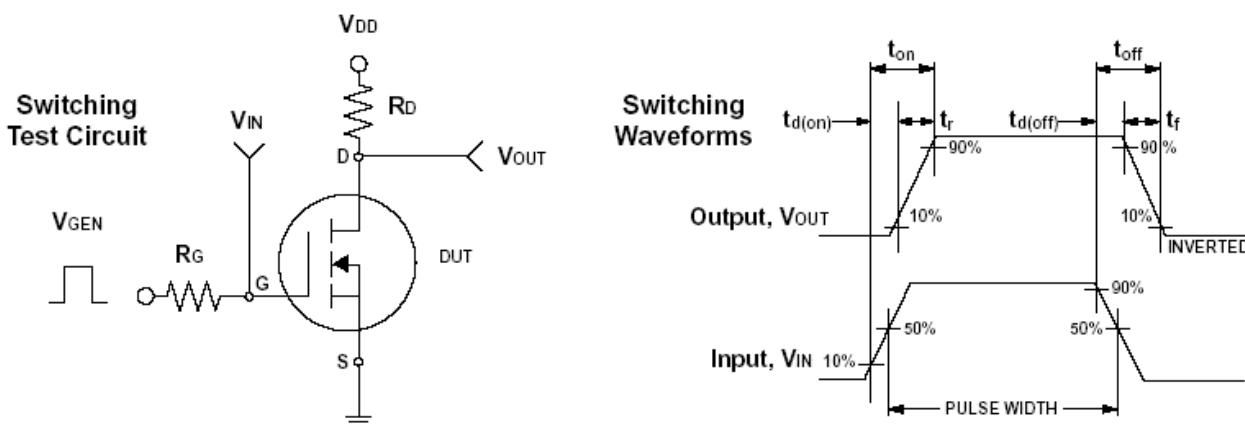
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±2	
Continuous Drain Current	I <sub>D</sub>	5.8	A
Pulsed Drain Current	I <sub>PM</sub>	30	
Maximum Power Dissipation	P <sub>D</sub>	1.4	W
		1	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C
Junction-to-Ambient Thermal Resistance (PCB mounted)	R <sub>θJA</sub>	145	°C/W

## 30V N-Channel Enhancement Mode MOSFET

## ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Miax.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 5.8A$		25.0	30.0	$m\Omega$
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 5A$		30.0	33.0	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 2.5V, I_D = 4A$		40.0	52.0	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.7		1.4	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 24V, V_{GS} = 0V$			1	$\mu A$
Gate Body Leakage	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS} = 0V$			$\pm 100$	nA
Forward Transconductance	$g_{fs}$	$V_{DS} = 5V, I_D = 5A$	10	15	—	S
Gate Resistance	$R_g$	F=1.0MHz	6	7	7.5	$\Omega$
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS} = 15V, I_D = 5.8A$ $V_{GS} = 4.5V$		11		$nC$
Gate-Source Charge	$Q_{gs}$			1.6		
Gate-Drain Charge	$Q_{gd}$			2.8		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15V, RL = 2.7\Omega$ $I_D = 1A, V_{GEN} = 10V$ $R_G = 3\Omega$		7		$ns$
Turn-On Rise Time	$t_r$			15		
Turn-Off Delay Time	$t_{d(off)}$			38		
Turn-Off Fall Time	$t_f$			3		
Input Capacitance	$C_{iss}$	$V_{DS} = 10V, V_{GS} = 0V$ $f = 1.0 \text{ MHz}$		340		$pF$
Output Capacitance	$C_{oss}$			115		
Reverse Transfer Capacitance	$C_{rss}$			33		
<b>Source-Drain Diode</b>						
Max. Diode Forward Current	$I_s$				1.6	A
Diode Forward Voltage	$V_{SD}$	$I_s = 1.6A, V_{GS} = 0V$			1.2	V

Note: Pulse test: pulse width <= 300us, duty cycle<= 2%



## 30V N-Channel Enhancement Mode MOSFET

## Characteristics Curve

